

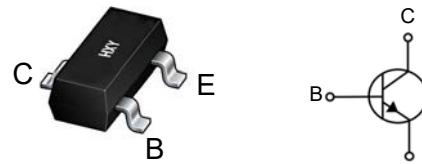


Features

- Collector Current Capability $I_C=0.5A$
- Collector Emitter Voltage $V_{CEO}=80V$

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
PMBTA06	SOT-23	1GM	3000



SOT-23

Maximum Ratings ($T_a=25^\circ C$ unless otherwise noted)

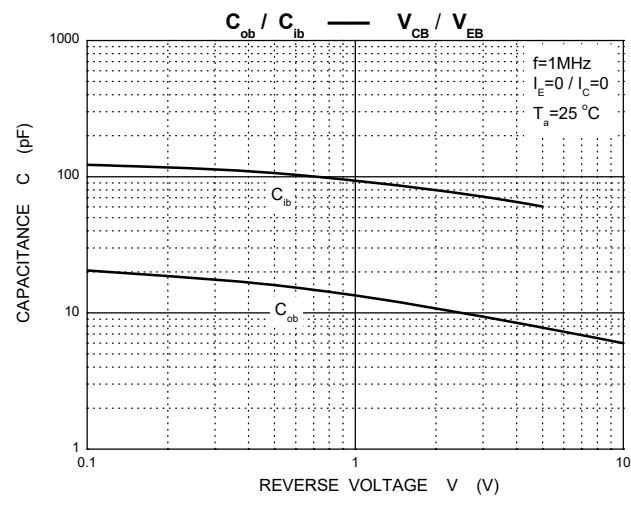
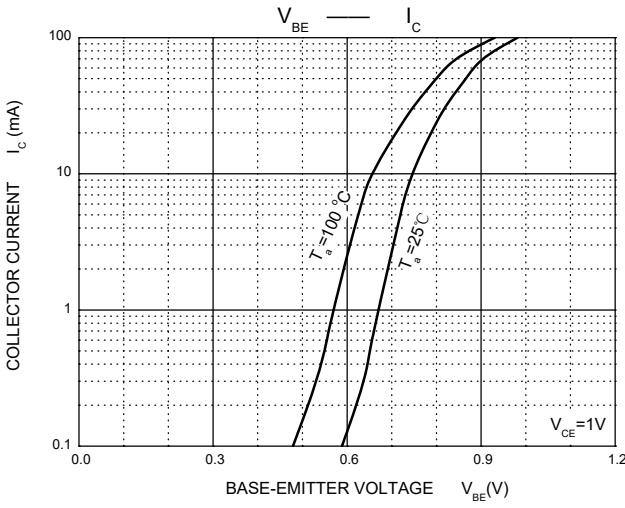
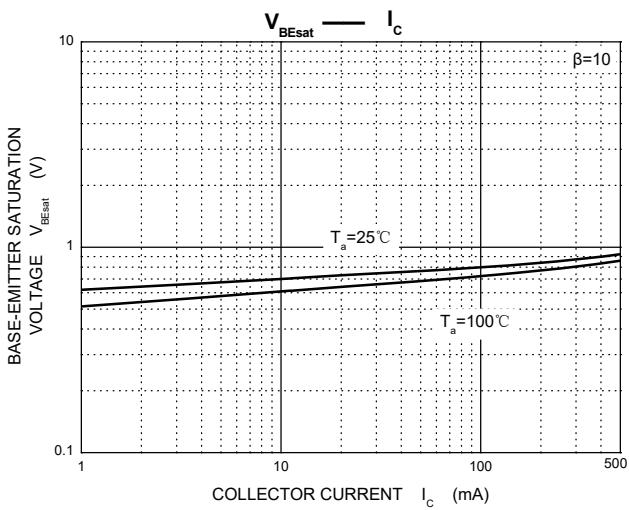
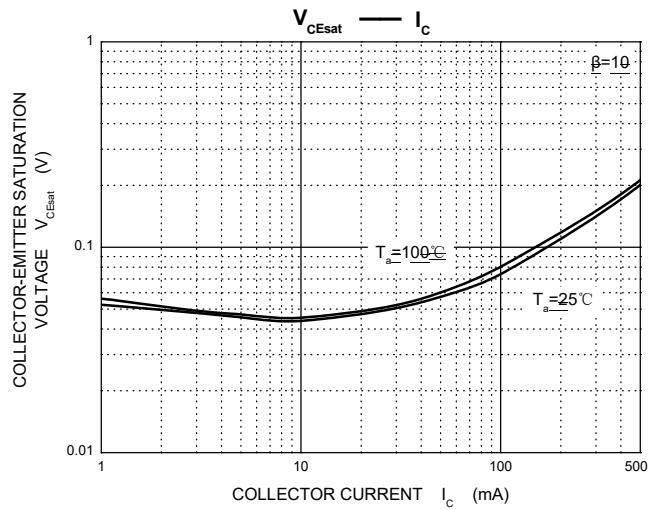
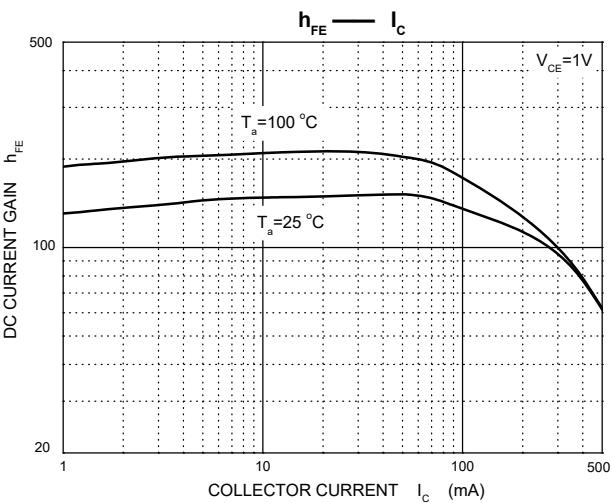
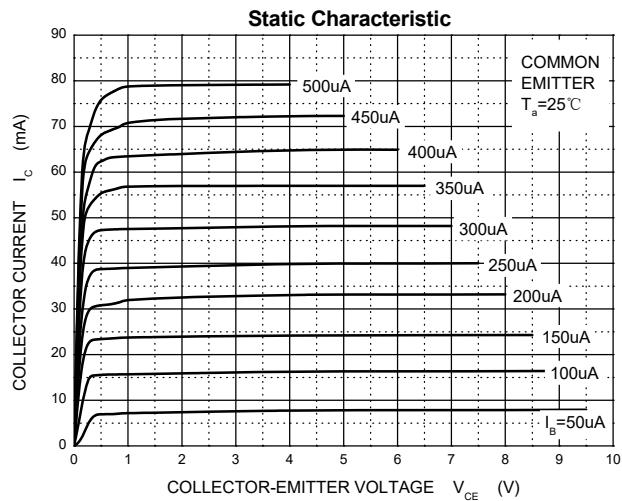
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V_{CBO}	80	V
Collector-Emitter Voltage	V_{CEO}	80	V
Emitter-Base Voltage	V_{EBO}	4	V
Collector Current	I_C	500	mA
Collector Power Dissipation	P_c	300	mW
Thermal Resistance From Junction To Ambient	$R_{\Theta JA}$	416	$^\circ C/W$
Junction Temperature	T_j	150	$^\circ C$
Storage Temperature	T_{stg}	-55~+150	$^\circ C$

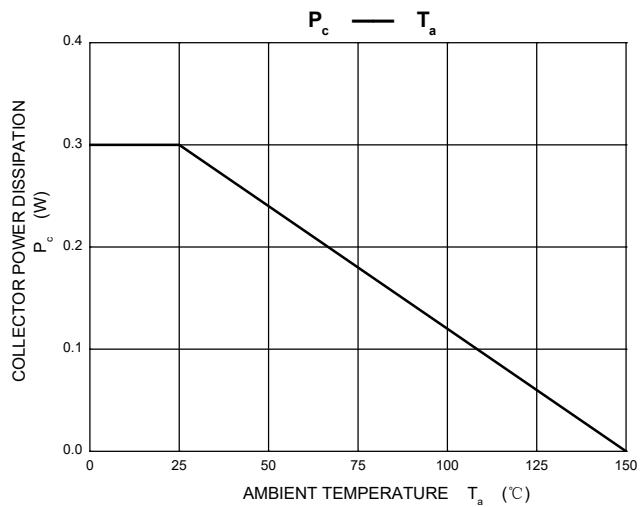
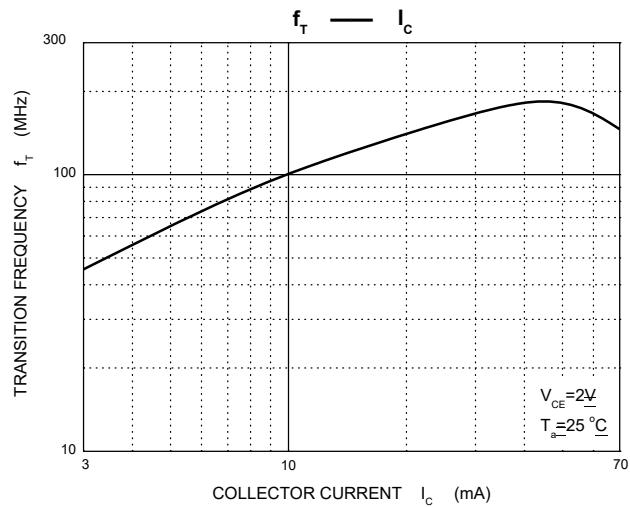
Electrical Characteristics($T_a=25^\circ C$ unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=0.1mA, I_E=0$	80		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=1mA, I_B=0$	80		V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=0.1mA, I_C=0$	4		V
Collector cut-off current	I_{CBO}	$V_{CB}=80V, I_E=0$		0.1	μA
Collector cut-off current	I_{CEO}	$V_{CE}=60V, I_B=0$		1	μA
Emitter cut-off current	I_{EBO}	$V_{EB}=3V, I_C=0$		0.1	μA
DC current gain	$h_{FE(1)}$	$V_{CE}=1V, I_C=10mA$	100	400	
	$h_{FE(2)}$	$V_{CE}=1V, I_C=100mA$	100		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=100mA, I_B=10mA$		0.25	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C=100mA, I_B=10mA$		1.2	V
Transition frequency	f_T	$V_{CE}=2V, I_C=10mA, f=100MHz$	100		MHz



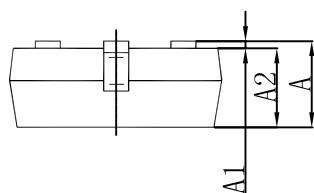
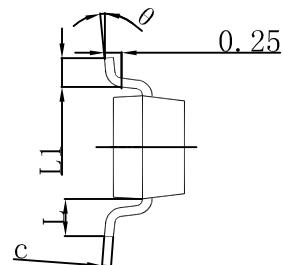
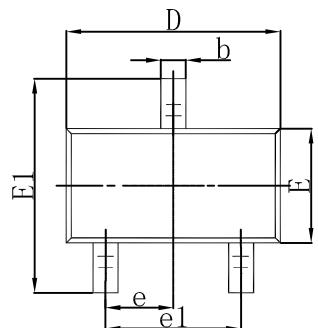
Typical Characteristics





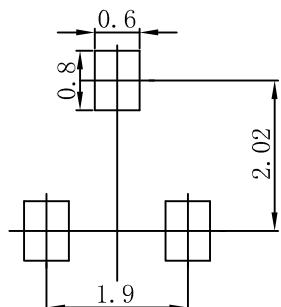


SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.



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